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**Bib Data Sheet** 

**CONFIRMATION NO. 3315** 

SERIAL NUMBER 10/761,412	FILING OR 371(c)  DATE  01/22/2004  RULE	<b>CLASS</b> 228	GROUP ART UNIT 1725		D	ATTORNEY OCKET NO. 2004-0092
Shoriki Narita, I Masahiko Ikeya Shinji Kanayam Takaharu Mae,  ** CONTINUING DAT This application  ** FOREIGN APPLICATION	ni, Neyagawa-shi, JAPA dirakata-shi, JAPAN; n, Neyagawa-shi, JAPA na, Kashihara-shi, JAPA Hirakata-shi, JAPAN; nis a DIV of 09/719,768 ATIONS ************************************	N; NN; 8 12/18/2000 PAT 6,787	7,391 <del>}}</del>	٨		Ŷ
Foreign Priority claimed  35 USC 119 (a-d) conditions  met  Verified and Acknowledged  Examiner's Signature  ADDRESS  000513			SHEE DRAW 15	WING CLAIMS		INDEPENDENT CLAIMS 1
Method of forming bumps on a wafer utilizing a post-heating operation, and  FILING FEE FEES: Authority has been given in Paper RECEIVED No to charge/credit DEPOSIT ACCOUNT No for following:				an apparatus therefore  All Fees  1.16 Fees (Filing)  1.17 Fees (Processing Ext. of time)  1.18 Fees (Issue)  Other  Credit		